# BW Papersystems Kugler-Womako

# PassPort 2





# PassPort Machine for Laminating Features

- Suitable for (electronic) Machine Readable Travel Document (eMRTD) according to ISO and ICAO standards
- High productivity and reliable production in terms of quality and output
- Sophisticated technology for easy operation and maintenance
- Rigid design for increased life expectancy (>30 years)
- Modular layout in order to accomodate various types of passports and future upgrades

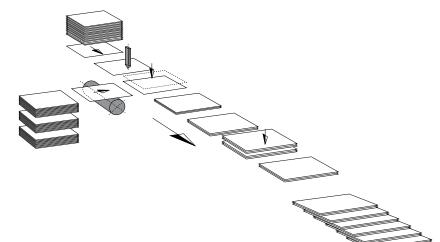




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# PassPort 2



The PassPort 2 machine laminates covers, e-covers and/or chip-inlays onto layers sewn by PassPort 1. All styles of passports and e-passports can be manufactured by combining the PassPort 2 with our PassPort 1, 3 and 4 machines.

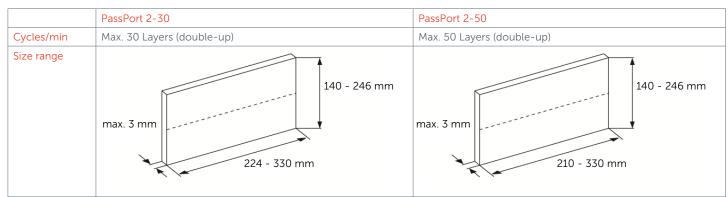
#### Passport 2 basic equipment

- Feeder for sewn layers
- Seam gluing with cold glue
- Feeding of cover material, e-covers and/or chip-inlays
- Laminating of cover material or chip-inlays
- Pressing of layers
- Delivery

## **Add-on options**

- Seam gluing with UV curable glue
- Secondary feeding and secondary lamination station for additional lamination of chip-inlays, to get chip-inlay and cover onto sewn layer in one working step
- Pile press for improved adhesion especially with cold glue
- Chip verification with automatic rejection of defective chip-inlays or e-covers (without interruption of the production process),
- marking rejects by labeling
- Registration of Chip-UIDs used and other tracking features
- Inline connection to PassPort 1 and PassPort 3
- Optionally PUR hotmelt instead of cold glue

## **Technical data**





Gluing cylinder



Feeding



Pile press

# World market leader for over 50 years

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